

**IN THE CLAIMS**

Please substitute claim 7 with the following:

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1. (Original) A printed wiring board comprising:  
a glass substrate provided with through-holes;  
conductive patterns provided on both surfaces of said glass substrate in such a manner as  
to be made conductive to each other via said through-holes; and  
a sealing member provided to fill said through-holes.
  2. (Original) A printed wiring board according to claim 1, wherein said glass  
substrate is a no-alkali glass substrate.
  3. (Original) A printed wiring board according to claim 1, wherein said sealing  
member is a conductive paste containing an epoxy resin as a binder.
  4. (Original) A printed wiring board according to claim 1, wherein a conductive  
film is provided on an inner wall surface of each of said through-holes in such a manner as to  
connect said conductive patterns provided on both surfaces of said glass substrate to each other,  
and  
an inner space, inside said conductive film, of said through-hole is filled with said sealing  
member.
  5. (Original) A printed wiring board according to claim 4, wherein said sealing  
member is an epoxy resin.
  6. (Original) A printed wiring board according to claim 4, wherein the surface of  
said sealing member exposed from each of said through-holes is covered with a metal film.
  7. (Currently amended) A printed wiring board according to claim 1, comprising:

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a glass substrate provided with a plurality of through-holes;

a plurality of conductive patterns provided on both surfaces of said glass substrate in such a manner as to be made conductive to each other via said through-holes; and

a sealing member provided to fill said through-holes,

wherein each of said conductive patterns has a stacked structure of a chromium film and a copper film formed thereon.

8. (Original) A printed wiring board according to claim 1, wherein each of said conductive patterns has a stacked structure of an epoxy resin film and a copper film formed thereon.

9. (Original) A display apparatus comprising:

a printed wiring board including a glass substrate provided with through-holes, conductive patterns provided on both surfaces of said glass substrate in such a manner as to be made conductive to each other via said through-holes, and a first sealing member provided to fill said through-holes;

a display device provided on one surface of said printed wiring board in such a manner as to be connected to said conductive pattern provided on said one surface of said printed wiring board;

a drive component for driving said display device, said drive component being disposed on the other surface of said printed wiring board in such a manner as to be connected to said conductive pattern provided on said other surface of said printed wiring board;

a protective glass board disposed in such a manner as to face to said one surface of said printed wiring board; and

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a second sealing member provided in such a manner as to surround said display device while being in contact with said printed wiring board and said protective glass board.

10. (Original) A display apparatus according to claim 9, wherein said glass substrate is a no-alkali glass substrate.

11. (Original) A display apparatus according to claim 9, wherein said first sealing member is a conductive paste containing an epoxy resin as a binder.

12. (Original) A display apparatus according to claim 9, wherein a conductive film is provided on an inner wall surface of each of said through-holes in such a manner as to connect said conductive patterns provided on both surfaces of said glass substrate to each other, and

an inner space, inside said conductive film, of said through-hole is filled with said first sealing member.

13. (Original) A display apparatus according to claim 12, wherein said first sealing member is an epoxy resin.

14. (Original) A display apparatus according to claim 12, wherein the surface of said first sealing member exposed from each of said through-holes is covered with a metal film.

15. (Original) A display apparatus comprising:

a printed wiring board including a glass substrate provided with through-holes, conductive patterns provided on both surfaces of said glass substrate in such a manner as to be made conductive to each other via said through-holes, and a first sealing member provided to fill said through-holes;

bumps provided on said conductive pattern provided on one surface of said printed wiring board;

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a protective glass board disposed in such a manner as to face to said one surface of said printed wiring board;

a display device provided on the surface, facing to said printed wiring board, of said protective glass board in such a manner as to be connected to said bumps;

a drive component for driving said display device, said drive component being disposed on the other surface of said printed wiring board in such a manner as to be connected to said conductive pattern provided on said other surface of said printed wiring board; and

a second sealing member provided in such a manner as to surround said display device while being in contact with said printed wiring board and said protective glass board.

16. (Original) A display apparatus according to claim 15, wherein said glass substrate is a no-alkali glass substrate.

17. (Original) A display apparatus according to claim 15, wherein said first sealing member is a conductive paste containing an epoxy resin as a binder.

18. (Original) A display apparatus according to claim 15, wherein a conductive film is provided on an inner wall surface of each of said through-holes in such a manner as to connect said conductive patterns provided on both surfaces of said glass substrate to each other, and an inner space, inside and conductive film, of said through-hole is filled with said first sealing member.

19. (Original) A display apparatus according to claim 18, wherein said first sealing member is an epoxy resin.

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20. (Original) A display apparatus according to claim 18, wherein the surface of said first sealing member exposed from each of said first sealing member exposed from each of said through-holes is covered with a metal film.

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